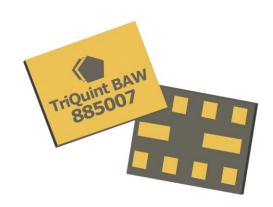


Applications

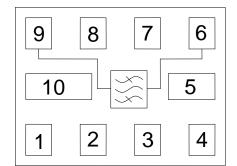
- WiFi bandpass filter that enables the coexistence of 4G (WiMAX/LTE/TD-LTE) & WiFi signals
- Handsets
- Portable Hotspots
- Mobile Routers
- Smart Meters
- High-power WLAN Access Points
- Applicable reject bands: 2.6 GHz WiMAX/LTE,
 2.3GHz WiMAX/LTE, LTE Bands 7 & 38, TD-LTE
 Band 40, WCS, WiBro, Indian 2.3GHz 4G band



1.7 x 1.3 x 0.46 mm

Functional Block Diagram

Top view



Product Features

- Low Loss in 2400-2472 MHz band
- High Rejection in 2496-2690 MHz bands: WiMAX/LTE/TD-LTE/Bands 7 & 38
- High Rejection in 2300-2380 MHz bands: WiMAX/WCS/WiBro/Band 40/Indian 4G band
- Industry-leading small size: 1.7 x 1.3 x 0.46 mm
- +28 dBm (CW) power handling
- Performance over -30 to +85 °C
- Single-ended operation
- Ceramic chip-scale package (CSP)
- Hermetically Sealed
- RoHS compliant, Pb-free

General Description

885007 is a high-performance, high-power Bulk Acoustic Wave (BAW) bandpass filter with extremely steep skirts, simultaneously exhibiting low loss in the WiFi band & high near-in rejection in the 2.3GHz & 2.6GHz WiMAX/LTE/TD-LTE bands.

885007 is specifically designed to enable coexistence of WiFi and WiMAX/LTE signals within the same device or in close proximity to one another.

885007 uses advanced and inexpensive packaging techniques to achieve an industry-leading 1.7 x 1.3 x 0.46 mm package. The filter exhibits excellent power handling capabilities.

885007 is referenced on multiple designs with the leading WiMAX chipset makers

Pin Configuration

Pin # SE	Description
9	Input
6	Output
1,2,3,4,5,7,8,10	Case Ground

Ordering Information

Part No.	Description
885007	packaged part
885007-EVB	evaluation board

Standard T/R size = 10,000 units/reel.

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Specifications

Electrical Specifications (1)

Specified Temperature Range: (2) -30 to +85 °C (unless otherwise noted)

Parameter	Conditions	Min	Typical (3)	Max	Units
Center Frequency		_	2436	-	MHz
Maximum Insertion Loss	2400 - 2472 MHz @ 25 °C	-	1.8	2.5	dB
	2400 - 2472 MHz	_	_	3.5	dB
	2401 - 2480 MHz	_	4.5	-	dB
	2480 - 2482 MHz ⁽⁶⁾	-	7.0	-	dB
Absolute Attenuation (4)	800 - 2000 MHz	22	25	-	dB
	2000 - 2300 MHz	24	26	-	dB
	2300 - 2360 MHz	30	36	-	dB
	2360 - 2370 MHz ⁽⁶⁾	15	20	-	dB
	2370 - 2380 MHz ⁽⁶⁾	5	8	-	dB
	2495 - 2517 MHz @ 25 °C	20	34	-	dB
	2495 - 2517 MHz	12.5	-	-	dB
	2496 - 2502 MHz ⁽⁷⁾	-	52	-	dB
	2500 - 2502 MHz	-	50	-	dB
	2500 - 2510 MHz ⁽⁷⁾	26	55	-	dB
	2502 - 2690 MHz	25	30	-	dB
	2690 - 5000 MHz	25	28	-	dB
	7200 - 7416 MHz	-	14	-	dB
Amplitude Ripple	2400 - 2472 MHz (within any	-	1.3	2.0	dB p-p
	18MHz Channel)				
Input/output Return Loss	2400 - 2472MHz	6.0	14	-	dB
Source Impedance (single-ended) (5)		-	50	-	Ω
Load Impedance (single-ended) (5)		-	50	-	Ω

Notes:

- 1. All specifications are based on the TriQuint schematic for the main reference design shown on page 3
- In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
- 3. Typical values are based on average measurements at room temperature
- 4. Relative to zero dB
- 5. This is the optimum impedance in order to achieve the performance shown
- 6. These bands fall on the filter transitions, thus the typical attenuation/loss values given are prone to high variability
- 7. Average attenuation level over the band

Absolute Maximum Ratings

Parameter (8)	Rating
Operating Temperature	-30 to +85 °C
Storage Temperature	-40 to +85 °C
Input Power ⁽⁹⁾ (In passband, CW signal)	+28 dBm

- 8. Operation of this device outside the parameter ranges given above may cause permanent damage.
- 9. Represents the maximum allowable power level without electrical degradation equivalent to duration of 10,000 hours at 55°C

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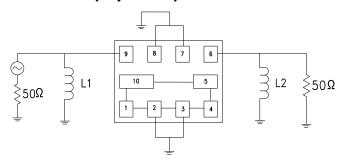
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Reference Design – 50Ω SE Input, 50Ω SE Output

Schematic (top view)



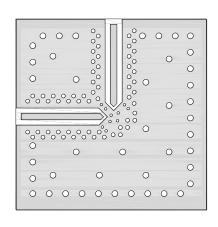
Pin Functions

9	Input
6	Output
1,2,3,4,5,7,8,10	Ground

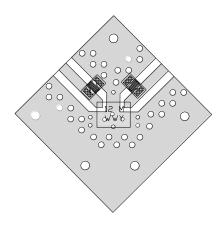
1. Notes:

Actual matching values may vary due to PCB layout and parasitic

PC Board



PCB routing detail



Notes:

Top, middle & bottom layers: 1 oz copper Substrates: FR4 dielectric, .031" thick

Finish plating: Nickel: 3-8µm thick, Gold: .03-.2µm thick

Hole plating: Copper min .0008µm thick

Notes:

- 1. Grey indicates metalized area
- 2. This footprint represents a recommendation only
- 3. For solder pad recommendation see mechanical information

Bill of Material

Reference Desg.	Value	Description	Manufacturer	Part Number
L1	10nH	Coil Wire-wound, 0402, +/- 0.2nH	MuRata	LQW15AN1N0C00
L2	12nH	Coil Wire-wound, 0402, +/- 0.2nH	MuRata	LQW15AN1N2C00
PCB	N/A	3-layer	multiple	960850

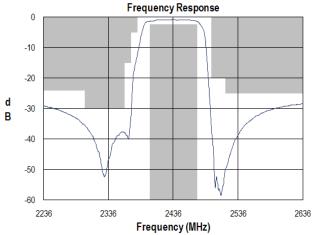
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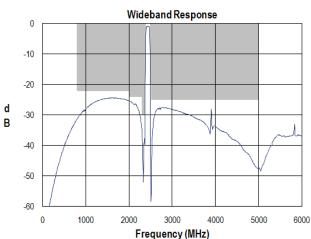
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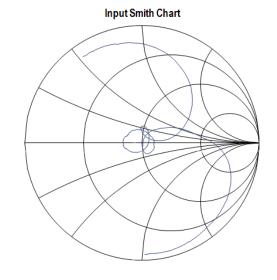
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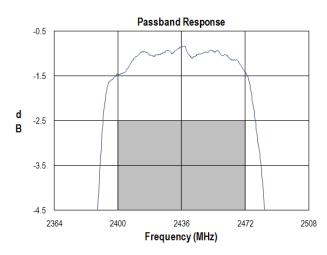


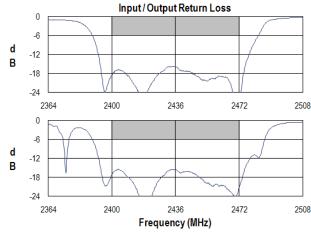
Typical Performance (at room temperature)

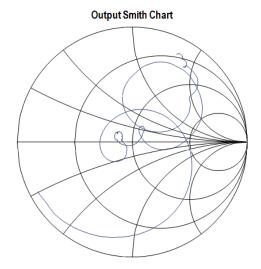












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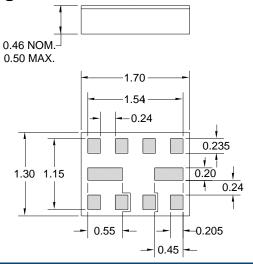
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Mechanical Information

Package Information, Dimensions and Marking



Package Style: CSP-1713

Dimensions: 1.70 x 1.30 x 0.46 mm

Body: Al_2O_3 ceramic Lid: Kovar, Ni plated

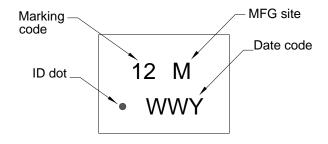
Terminations: Au plating 0.5 - 1.0μm, over a 2-6μm Ni

plating

All dimensions shown are nominal in millimeters All tolerances are ± 0.15 mm except overall length and width

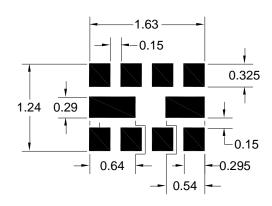
±0.10mm

Marking



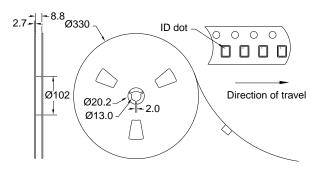
The date code consists of: WW = 2 digit week, Y = last digit of year, M = manufacturing site code

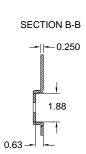
PCB Footprint

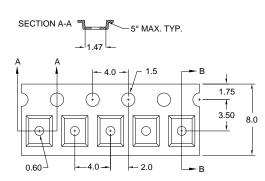


Tape and Reel Information

Standard T/R size = 10,000 units/reel. All dimensions are in millimeters







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Product Compliance Information

ESD Information



Caution! ESD-Sensitive Device

ESD Rating: 3A

Value: Passes ≥ 6000 V min.

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114

ESD Rating: C

Value: Passes ≥ 400 V min. Test: Machine Model (MM)

Standard: JEDEC Standard JESD22-A115

MSL Rating

Devices are hermetic, therefore MSL is not applicable.

Solderability

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to **Soldering Profile** for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A $(C_{15}H_{12}Br_4O_2)$ Free
- PFOS Free
- SVHC Free

Contact Information

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